

## Product Summary

Symbol	Value	Unit
$I_{T(AV)}$	2.0	A
$V_{DRM} V_{RRM}$	600	V
$I_{GT}$	200	$\mu A$

## Feature

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference.

## Application

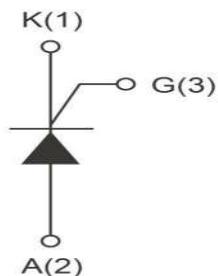
Power charger, T-tools, massager, solid state relay, AC Motor speed regulation and so on.

## Package

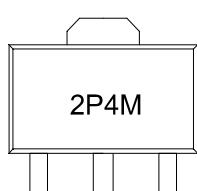


SOT-89-3L

## Circuit diagram



## Marking



**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V <sub>DRM</sub>	600	V
Repetitive peak reverse voltage	V <sub>RRM</sub>	600	V
RMS on-state current	I <sub>T(RMS)</sub>	3	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I <sub>TSM</sub>	20	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	2	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI <sub>T</sub> /dt	50	A/μs
Peak gate current	I <sub>GM</sub>	0.2	A
Average gate power dissipation	P <sub>G(AV)</sub>	0.1	W
Junction Temperature	T <sub>J</sub>	-40 ~ +110	°C
Storage Temperature	T <sub>STG</sub>	-40 ~ +150	°C

**Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition	Value		Unit
			Min	Max	
Gate trigger current	I <sub>GT</sub>	V <sub>D</sub> =12V I <sub>T</sub> =10mA T <sub>j</sub> =25°C	10	200	μA
Gate trigger voltage	V <sub>GT</sub>		-	0.8	V
Gate non-trigger voltage	V <sub>GD</sub>	V <sub>D</sub> =1/2V <sub>DRM</sub> T <sub>j</sub> =110°C	0.2	-	V
latching current	I <sub>L</sub>	V <sub>D</sub> =12V I <sub>G</sub> =0.5mA R <sub>GK</sub> =1kΩ T <sub>j</sub> =25°C	-	3	mA
Holding current	I <sub>H</sub>		-	4	mA
Critical-rate of rise of commutation voltage	dV <sub>D</sub> /dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =110°C	10	-	V/μs

**STATIC CHARACTERISTICS**

Forward "on" voltage	V <sub>TM</sub>	I <sub>TM</sub> =4A tp=380μs		-	1.55	V	
Repetitive Peak Off-State Current	I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub>	V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25°C	-	5	μA
Repetitive Peak Reverse Current	I <sub>RRM</sub>			T <sub>j</sub> =110°C	-	0.1	mA

**THERMAL RESISTANCES**

Thermal resistance	R <sub>th(j-c)</sub>	Junction to case		TYP.	20	°C/W
	R <sub>th(j-a)</sub>	Junction to ambient		TYP.	60	°C/W

## Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

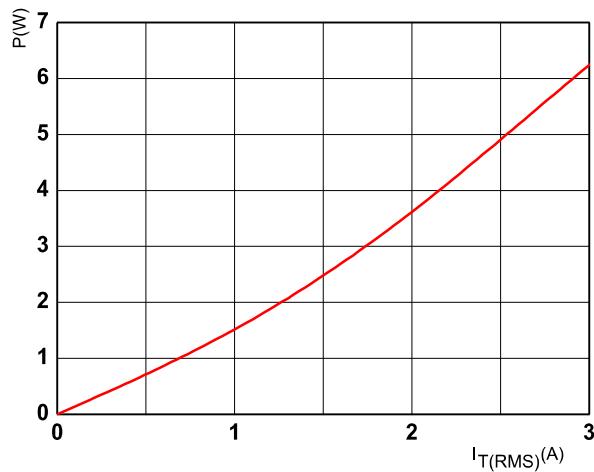


FIG.2: RMS on-state current versus case temperature (full cycle)

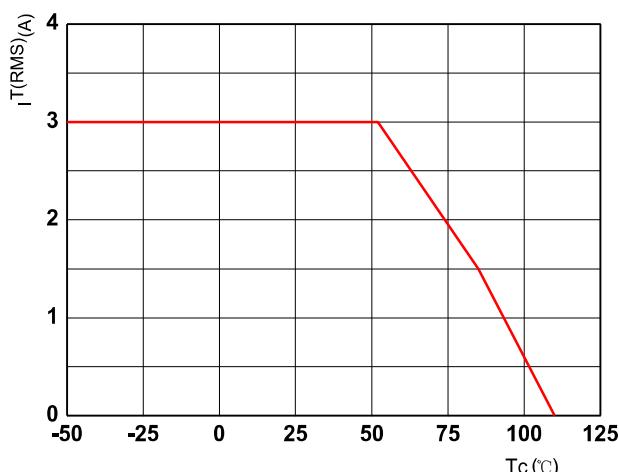


FIG.3: Surge peak on-state current versus number of cycles

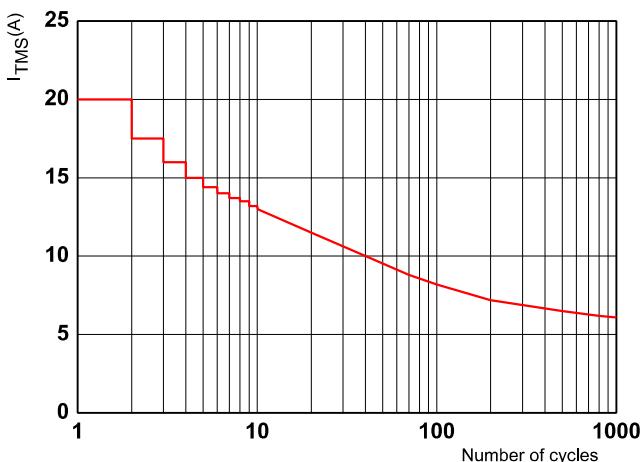


FIG.4: On-state characteristics (maximum values)

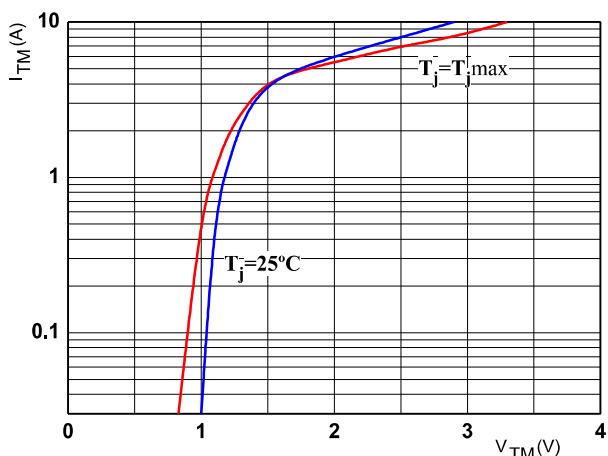


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10ms

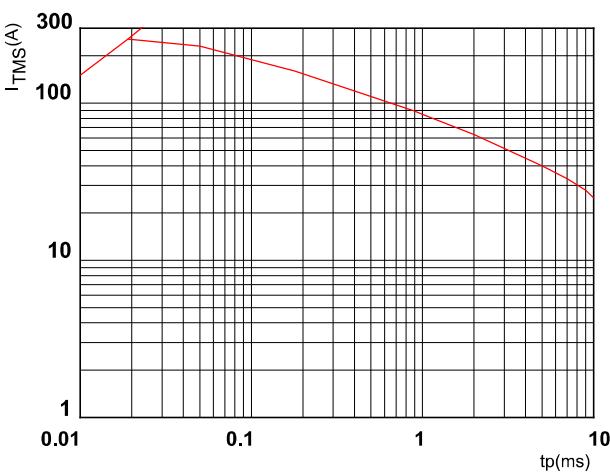
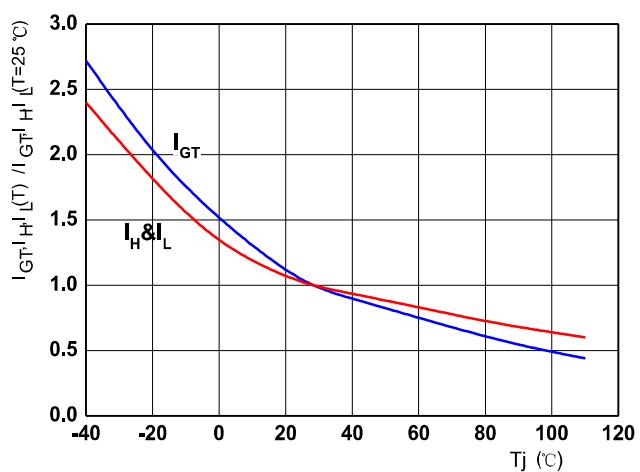
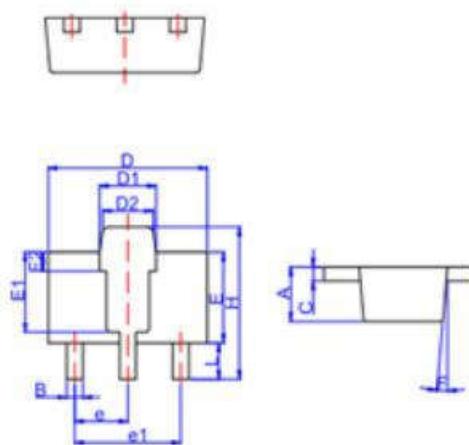


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



### SOT-89-3L Package Information



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.40		1.60	0.055		0.063
B	0.35		0.52	0.014		0.020
C	0.35		0.46	0.014		0.018
D	4.30		4.70	0.169		0.185
D1	1.50		1.70	0.059		0.067
D2	1.30		1.50	0.051		0.059
E	2.30		2.70	0.091		0.106
E1		2.20			0.087	
E2		0.52			0.020	
e		1.50			0.059	
e1		3.00			0.118	
F		5°			5°	
H	3.94		4.0	0.155		0.157
L	0.80		1.20	0.031		0.047